

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

PRELIMINARY AMENDMENT ACCOMPANYING APPLICATION

APPLICANT: Akira Yoshizawa, et al. ATTY. DOCKET NO. 09792909-5237

SERIAL NO.

DATE FILED:

INVENTION: "SEMICONDUCTOR DEVICE USING INTERPOSER SUBSTRATE AND
MANUFACTURING METHOD THEREFOR"

Assistant Commissioner of Patents
Washington, D.C. 20231


S I R:

Between the title and the heading "Background of the Invention" on page 1, insert the following:

--RELATED APPLICATION DATA

The present application claims priority to Japanese Application(s) No(s). P2000-309506 filed October 10, 2000, and P2001-147024 filed May 16, 2001, which application(s) is/are incorporated herein by reference to the extent permitted by law.--

Respectfully submitted,



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